

IFW



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE  
PATENT APPLICATION

In re Application of:

Venkateswaran

Atty. Docket: TI-34105.1

Serial No.: 10/789,646

Art Unit: 2813

Filed: 03/01/2004

Examiner: J. Dolan

For: SEMICONDUCTOR DEVICE PACKAGE AND METHOD OF MAKING THE  
SAME

Commissioner for Patents  
P. O. Box 1450  
Alexandria, VA 22313-1450

CERTIFICATE OF MAILING 37 CFR §1.8(a)

I hereby certify that this correspondence is being deposited with the United States Postal Service as First Class Mail in an envelope addressed to: Commissioner for Patents, Alexandria, VA 22313-1450 on the date indicated below.

10-5-2005  
*Jackie McBride*  
Jackie McBride

**LETTER TO THE OFFICIAL DRAFTSPERSON**

Sir:

Please find enclosed eight (8) sheets of replacement formal drawings in the patent application referenced above.

Respectfully submitted,

Texas Instruments Incorporated  
P. O. Box 655474, M/S 3999  
Dallas, Texas 75265  
(972) 917-4371

Wade James Brady III  
Attorney for Applicant  
Reg. No. 32,080